

## **General Description**

The WSD4064DN is the highest performance trench Dual N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD4064DN meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

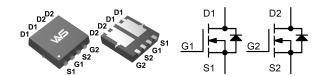
## **Product Summery**

BVDSS	RDSON	ID
40V	19mΩ	13A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## **DFN3x3-8-EP Pin Configuration**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit		
Commo	n Ratings				
V <sub>DSS</sub>	Drain-Source Voltage	40	V		
V <sub>GSS</sub>	Gate-Source Voltage	±20	V		
TJ	Maximum Junction Temperature	150	°C		
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C		
Is	Diode Continuous Forward Current	T <sub>A</sub> =25°C	4	А	
I <sub>D</sub>		T <sub>A</sub> =25°C	13	А	
	Continuous Drain Current	T <sub>A</sub> =70°C	9.5		
In., a	Pulse Drain Current Tested	T <sub>A</sub> =25°C	25	Α	
P <sub>D</sub>	Maximum Dayor Dissination	T <sub>A</sub> =25°C	2.5	W	
	Maximum Power Dissipation	T <sub>A</sub> =70°C	1.68		
$R_{\theta JL}$	Thermal Resistance-Junction to Lead	Steady State	10	°C/W	
$R_{\theta JA}$	The amount Description on the Ameliana	t≤10s	42.5	- °C/W	
	Thermal Resistance-Junction to Ambient	Steady State <sup>b</sup>	50		
l <sub>AS</sub> c	Avalanche Current, Single pulse	L=0.5mH	10	А	
E <sub>AS</sub> c	Avalanche Energy, Single pulse	L=0.5mH	25	mJ	

Note a: Pulse width limited by max. junction temperature.

Note b: Surface Mounted on 1in2 pad area, t =999sec.

Note c: UIS tested and pulse width limited by maximum junction temperature 150 $_{\circ}$ C (initial temperature  $T_{j}$ =25 $_{\circ}$ C).



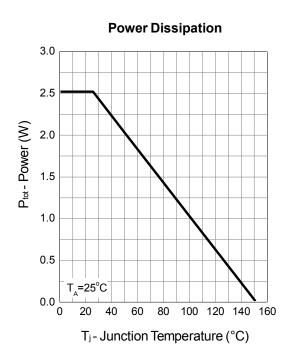
# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

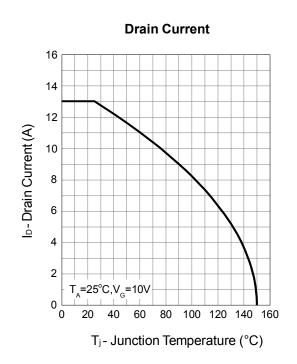
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Static Cha	aracteristics			•		•
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA	40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =32V, V <sub>GS</sub> =0V	-	-	1	- μΑ
		T <sub>J</sub> =85°C	-	-	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{DS}=250\mu A$	1.0	1.5	2.0	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
D C	Danier Courses On otata Basistanas	V <sub>GS</sub> =10V, I <sub>DS</sub> =6A	-	19	25	mΩ
R <sub>DS(ON)</sub> <sup>c</sup>	Drain-Source On-state Resistance	V <sub>GS</sub> =4.5V, I <sub>DS</sub> =5A	-	25	35	
Diode Cha	aracteristics	•				
V <sub>SD</sub> <sup>c</sup>	Diode Forward Voltage	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.75	1.1	V
t <sub>rr</sub>	Reverse Recovery Time	I -CA dl /dt-100A/va	-	12	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{DS}$ =6A, $dI_{SD}/dt$ =100A/ $\mu$ s	-	8.5	-	nC
Dynamic (	Characteristics <sup>d</sup>		•	•		
$R_G$	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	2.4	-	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V,	-	800	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =20V,	-	90	-	
C <sub>rss</sub>	Reverse Transfer Capacitance	Frequency=1.0MHz	-	55	-	
t <sub>d(ON)</sub>	Turn-on Delay Time	V <sub>DD</sub> =20V,	-	7.2	-	ns
t <sub>r</sub>	Turn-on Rise Time	RL=20Ω, IDS=1A,	-	6.5	-	
t <sub>d(OFF)</sub>	Turn-off Delay Time	VGEN=10V,	-	24	-	
t <sub>f</sub>	Turn-off Fall Time	RG=6 Ω	-	4.5	-	
Gate Char	rge Characteristics <sup>d</sup>					
Qg	Total Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> =10V, I <sub>DS</sub> =6A	-	15	21	
Qg	Total Gate Charge		-	8.2	10	
Q <sub>gth</sub>	Threshold Gate Charge	V <sub>DS</sub> =20V, V <sub>GS</sub> =4.5V,	-	1.7	-	nC
Q <sub>gs</sub>	Gate-Source Charge	I <sub>DS</sub> =6A	-	3.1	-	
$Q_{gd}$	Gate-Drain Charge		-	2.5	-	

Note c: Pulse test; pulse width $\leq$ 300 $\mu$ s, duty cycle $\leq$ 2%. Note d: Guaranteed by design, not subject to production testing.

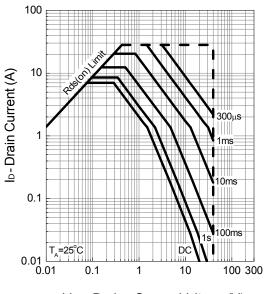


# **Typical Operating Characteristics**



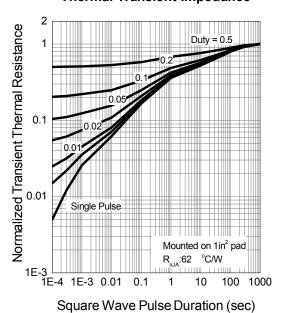


## Safe Operation Area



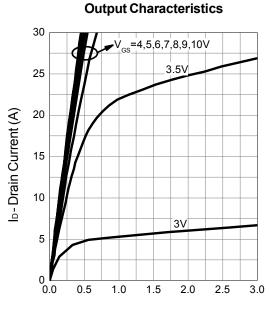
V<sub>DS</sub> - Drain - Source Voltage (V)

## **Thermal Transient Impedance**



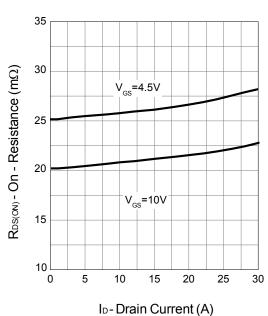


# **Typical Operating Characteristics (Cont.)**

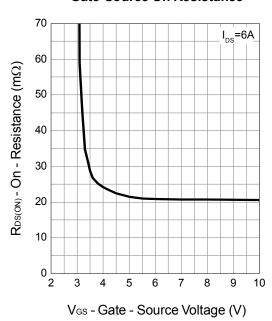


V<sub>DS</sub> - Drain - Source Voltage (V)

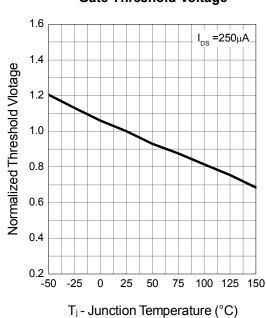
#### **Drain-Source On Resistance**



**Gate-Source On Resistance** 



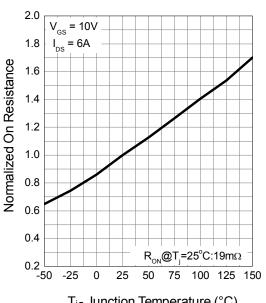
**Gate Threshold Voltage** 



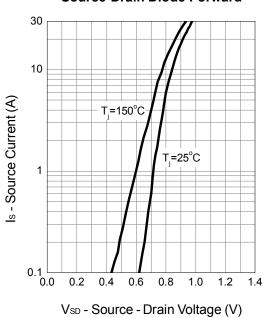


# **Typical Operating Characteristics (Cont.)**

# **Drain-Source On Resistance**

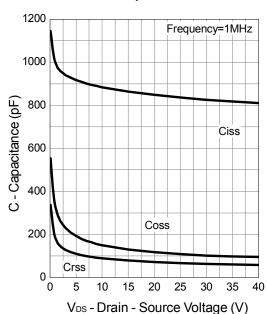


#### **Source-Drain Diode Forward**

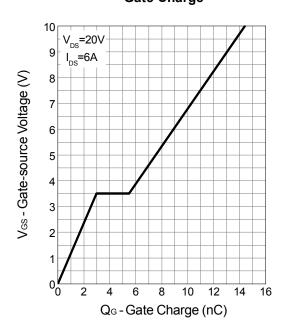


T<sub>j</sub>- Junction Temperature (°C)

## Capacitance



# **Gate Charge**





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